
Integracija procesne naprave (FDI®) - 3. del: Strežnik (IEC 62769-3:2023)

Field Device Integration (FDI®) - Part 3: Server (IEC 62769-3:2023)

Feldgeräteintegration (FDI®) - Teil 3: FDI-Server (IEC 62769-3:2023)

Intégration des appareils de terrain (FDI®) - Partie 3: Serveur (IEC 62769-3:2023)

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**Field Device Integration (FDI®) - Part 3: Server
(IEC 62769-3:2023)**

Intégration des appareils de terrain (FDI®) - Partie 3:
Serveur
(IEC 62769-3:2023)

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(IEC 62769-3:2023)

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EN IEC 62769-3:2023 (E)**European foreword**

The text of document 65E/856/CDV, future edition 3 of IEC 62769-3, prepared by SC 65E "Devices and integration in enterprise systems" of IEC/TC 65 "Industrial-process measurement, control and automation" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62769-3:2023.

The following dates are fixed:

- latest date by which the document has to be implemented at national (dop) 2024-02-09 level by publication of an identical national standard or by endorsement
- latest date by which the national standards conflicting with the (dow) 2026-05-09 document have to be withdrawn

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Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61804-3	-	Devices and integration in enterprise systems - Function blocks (FB) for process control and electronic device description language (EDDL) - Part 3: EDDL syntax and semantics	EN IEC 61804-3	-
IEC 61804-4	-	Devices and integration in enterprise systems - Function blocks (FB) for process control and electronic device description language (EDDL) - Part 4: EDD interpretation	EN IEC 61804-4	-
IEC 61804-5	-	Devices and integration in enterprise systems - Function blocks (FB) for process control and electronic device description language (EDDL) - Part 5: EDDL Built-in library	EN IEC 61804-5	-
IEC 62541-4	-	OPC Unified Architecture - Part 4: Services	EN IEC 62541-4	-
IEC 62541-7	-	OPC unified architecture - Part 7: Profiles	EN IEC 62541-7	-
IEC 62769-1	-	Field Device Integration (FDI®) - Part 1: Overview	-	-
IEC 62769-2	-	Field Device Integration (FDI®) - Part 2: Client	-	-
IEC 62769-4	-	Field Device Integration (FDI®) - Part 4: FDI Packages	-	-
IEC 62769-5	-	Field Device Integration (FDI®) - Part 5: FDI Information Model	-	-
IEC 62769-7	-	Field Device Integration (FDI®) - Part 7: Communication Devices	-	-



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**Field device integration (FDI®) –
Part 3: Server**

**Intégration des appareils de terrain (FDI®) –
Partie 3: Serveur**

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CONTENTS

FOREWORD	5
1 Scope	7
2 Normative references	7
3 Terms, definitions, abbreviated terms and acronyms	8
3.1 Terms and definitions	8
3.2 Abbreviated terms and acronyms	8
3.3 Conventions	9
4 Overview	9
5 Information Model	9
5.1 General	9
5.2 Online/Offline	10
5.2.1 Overview	10
5.2.2 Transfer to device	10
5.2.3 Transfer from device	11
5.2.4 Interactive Transfer to device	11
5.3 Access privileges	11
5.4 Private Parameters	11
5.5 Locking	12
5.6 EditContext	13
5.6.1 Concept and usage model	13
5.6.2 Services	14
5.6.3 NodeIds	14
5.6.4 Reading	14
5.6.5 Writing	15
5.6.6 Writing dominant and dependent Variables	15
5.6.7 Actions (EDD METHODS)	16
5.6.8 UIDs	16
5.6.9 Synchronization	17
5.7 Reading	17
5.7.1 General	17
5.7.2 Reading offline variables	18
5.7.3 Reading online variables	18
5.8 Writing	19
5.8.1 General	19
5.8.2 Write offline variables	20
5.8.3 Writing online variables	21
5.8.4 Writing to an EditContext	22
5.9 Subscription	23
5.9.1 General	23
5.9.2 Subscription of offline variables	24
5.9.3 Subscription of online variables	25
5.10 Device topology	26
5.10.1 General	26
5.10.2 Connection Points	26
5.10.3 Topology management	27
5.10.4 Topology scanning	30
5.10.5 Use of SCAN function	31

5.10.6	Validation of defined topology.....	31
5.11	User Interface Elements.....	32
5.11.1	User Interface Descriptions.....	32
5.11.2	User Interface Plug-ins	33
5.12	Actions	33
5.12.1	FDI® Server – FDI® Client interaction	33
5.12.2	Action state machine	36
5.12.3	Actions Proxies.....	37
5.12.4	INTERACTIVE_TRANSFER_TO_DEVICE Action	38
5.12.5	Actions, EDD Actions and Actions Proxies.....	39
6	OPC UA services.....	40
6.1	OPC UA profiles	40
6.2	Service error information.....	40
6.2.1	Overview	40
6.2.2	OPC UA services and their response.....	40
6.2.3	Mappings of EDDL response codes to OPC UA service response	41
6.3	Parameter value update during write service request	42
6.4	Localization	42
6.5	Audit events.....	42
7	Communication.....	42
7.1	Notation	42
7.2	General.....	43
7.2.1	Concepts	43
7.2.2	Terms	45
7.3	Communication Service processing.....	46
7.3.1	Communication Service invocation	46
7.3.2	Analyze communication path	46
7.3.3	Manage communication relations.....	47
7.3.4	Communication service request mapping	47
7.3.5	Communication service request propagation.....	48
7.3.6	Communication error handling	49
7.4	FDI® Communication Server specific handling.....	49
7.4.1	Discovery	49
7.4.2	Information Model synchronization.....	50
8	Parallel Execution within the FDI® Server	50
8.1	Motivation	50
8.2	Internal structure of the EDD interpreter.....	51
8.3	Rules for running an EDD entity	51
Annex A (informative)	FDI® Server functional structure	53
A.1	FDI® functional elements.....	53
A.2	FDI® Server extension.....	54
Annex B (informative)	Access privileges and user roles	56
B.1	User roles and usage case.....	56
B.2	Private data usage	57
Annex C (informative)	Parallel execution within the FDI® Server – Examples	58
C.1	Simple example for a synchronous execution.....	58
C.2	Example for a concurrent execution	58
C.3	Deadlock detection in concurrent execution	60

Annex D (informative) Read-Only mode for UID Views	61
D.1 Definition	61
Figure 1 – FDI® architecture diagram	7
Figure 2 – Locking services	12
Figure 3 – EditContext models	13
Figure 4 – Online EditContext state diagram for dominant and dependent Variables	15
Figure 5 – Offline EditContext state diagram for dominant and dependent Variables	16
Figure 6 – EditContext for EDD Methods	16
Figure 7 – Offline variable read	18
Figure 8 – Online variable read	19
Figure 9 – Offline variable write immediate	20
Figure 10 – Online variable write immediate	21
Figure 11 – Write with EditContext	23
Figure 12 – Offline variable subscription	24
Figure 13 – Online variable subscription	25
Figure 14 – Topology with Network objects (non-normative)	26
Figure 15 – Add Device to topology	28
Figure 16 – Remove Device from topology	29
Figure 17 – Scan topology	30
Figure 18 – Action execution	35
Figure 19 – Action state machine	36
Figure 20 – System communication integration example	43
Figure 21 – FDI® Communication Server integration example	44
Figure 22 – Gateway integration example	45
Figure 23 – Message propagation example scenario	48
Figure A.1 – Functional components of an FDI® Server	53
Figure A.2 – FDI® Server extensions	55
Figure B.1 – User roles and access privileges	56
Figure C.1 – Synchronous execution of two triggers	58
Figure C.2 – Concurrent execution of two triggers (step1)	58
Figure C.3 – Concurrent execution of two triggers (step 2)	59
Figure C.4 – Concurrent execution of two triggers (step 3)	59
Figure C.5 – Concurrent execution of two triggers (step 4)	59
Figure C.6 – Concurrent execution of two triggers	60
Table 1 – Action states	36
Table 2 – Action state transitions	37
Table 3 – EDD Action types and the EDD constructs that use them	39
Table 4 – OPC UA severity bits and EDDL response codes TYPE	41

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FIELD DEVICE INTEGRATION (FDI®) –

Part 3: Server

FOREWORD

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IEC 62769-3 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation. It is an International Standard.

This third edition cancels and replaces the second edition published in 2021. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) added interactive transfer to device.

The text of this International Standard is based on the following documents:

Draft	Report on voting
65E/856/CDV	65E/913/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/standardsdev/publications.

A list of all parts in the IEC 62769 series, published under the general title *Field device integration (FDI®)*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
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FIELD DEVICE INTEGRATION (FDI®) –

Part 3: Server

1 Scope

This part of IEC 62769 specifies the FDI^{®1} Server. The overall FDI[®] architecture is illustrated in Figure 1. The architectural components that are within the scope of this document have been highlighted in this figure. Annex A provides a functional description of the FDI[®] Server.

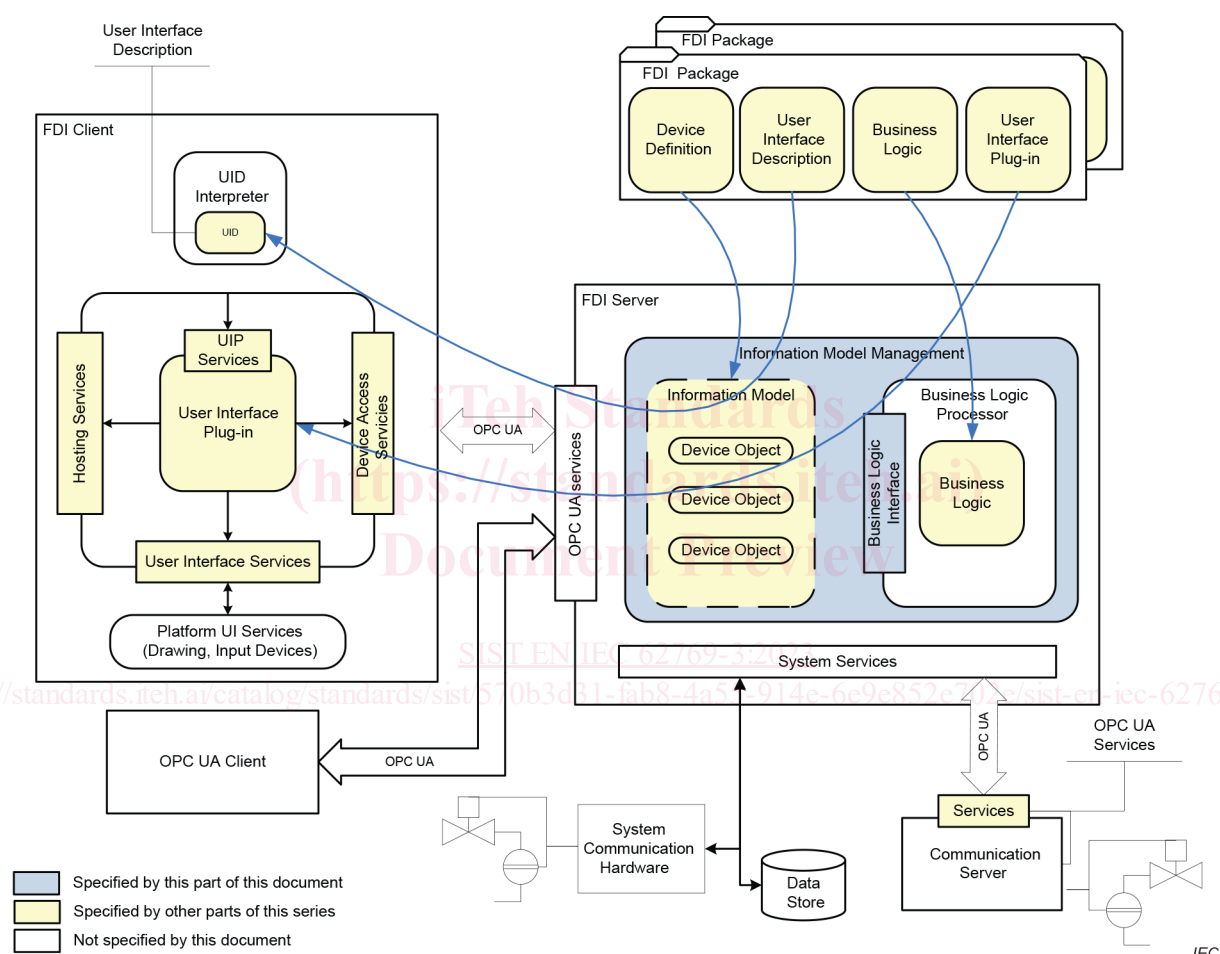


Figure 1 – FDI[®] architecture diagram

2 Normative references

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IEC 61804-4, *Devices and integration in enterprise systems – Function blocks (FB) for process control and electronic device description language (EDDL) – Part 4: EDD interpretation*

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IEC 62769-5, *Field Device Integration (FDI®) – Part 5: FDI® Information Model*

IEC 62769-7, *Field Device Integration (FDI®) – Part 7: Communication Devices*

3 Terms, definitions, abbreviated terms and acronyms

3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 62769-1 as well as the following apply.

ISO and IEC maintain terminology databases for use in standardization at the following addresses:

- IEC Electropedia: available at <https://www.electropedia.org/>
- ISO Online browsing platform: available at <https://www.iso.org/obp>

3.1.1

Actions Proxy

internal FDI® Server entity that encapsulates all the EDD Methods specified in an EDD Action definition

3.1.2

Connection Point

logical representation of a connection of a communication end point to a communication network

3.2 Abbreviated terms and acronyms

For the purposes of this document, the abbreviated terms and acronyms given in IEC 62769-1 apply.